

增加料号选型及视图		xushiyong 07.11.22	REVISION RECORD		
REV	ECO	DESCRIPTION	DRFT	CHKD	
△		原始版本	PEILEI 06.03.02		
△		增加料号,更改图号增加	xushiyong 07.02.01		

NOTES:

MATERIAL:

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE $\phi 0.46\text{mm}$
OR T=0.35 (C5100).
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD: COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

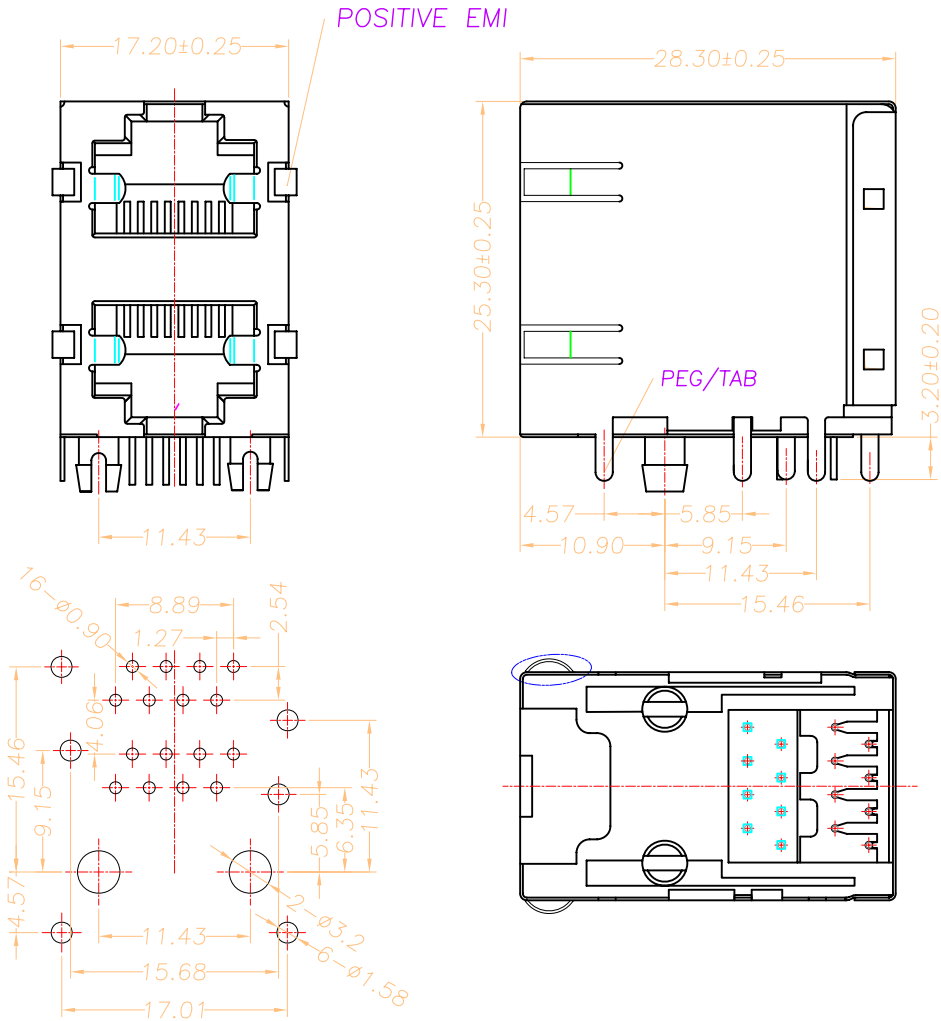
- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

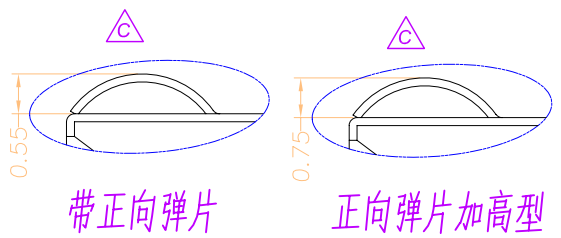
- 1.STORAGE : -40°C TO +85°C.
2. OPERATION : 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.

PART NUMBER:



PC Board Layout



DETACHED LISTS	MM (INCH)	设计	日期	Coorle 库乐科技
	一般公差栏	审核 GANBO	日期 06.03.02	
	MM	批准 xushiyong	日期 06.03.02	
	.0 ±0.20 .00 ±0.15 .000 ±0.075	材料:		
	角度 ± 0.01°	数量:		图号:
	表面处理:	比例:		料号:
	第三角视图			不按比例